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# **BLF640**

# **Broadband power LDMOS transistor**

Rev. 3 — 1 September 2015



### 1. Product profile

### 1.1 General description

10 W LDMOS power transistor for applications at frequencies from HF to 2200 MHz

Table 1. Typical performance

 $I_{Da}$  = 100 mA;  $T_{case}$  = 25 °C in a common source class-AB production test circuit.

Test signal	f	V <sub>DS</sub>	$P_{L(AV)}$	Gp	$\eta_{D}$	ACPR
	(MHz)	(V)	(W)	(dB)	(%)	(dBc)
2-carrier W-CDMA	2110 to 2170	28	0.7	18.5	15	-50 <u>[1]</u>
1-carrier W-CDMA	2110 to 2170	28	2	19.3	31	_39 <u>[1]</u>

<sup>[1]</sup> Test signal: 3GPP; test model 1; 64 DPCH; PAR = 7.5 dB at 0.01 % probability on CCDF per carrier; carrier spacing 5 MHz.

#### 1.2 Features and benefits

- Easy power control
- Integrated ESD protection
- Excellent ruggedness
- High efficiency
- Excellent thermal stability
- No internal matching for broadband operation
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

### 1.3 Applications

- RF power amplifiers for applications in the HF to 2200 MHz frequency range
- Broadcast drivers

### **Broadband power LDMOS transistor**

# 2. Pinning information

Table 2. Pinning

	9		
Pin	Description	Simplified outline	Graphic symbol
1	drain	<b>7</b> .	,
2	gate		<u>,                                    </u>
3	source	[1]	2 3 sym112

<sup>[1]</sup> Connected to flange.

# 3. Ordering information

Table 3. Ordering information

Type number	Package	e	
	Name	Description	Version
BLF640	-	ceramic surface-mounted package; 2 leads	SOT538A

# 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DS}$	drain-source voltage		-	65	V
$V_{GS}$	gate-source voltage		-0.5	+13	V
T <sub>stg</sub>	storage temperature		-65	+150	°C
T <sub>i</sub>	junction temperature		-	225	°C

### 5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
R <sub>th(j-case)</sub>	thermal resistance from junction to case	$T_{case}$ = 80 °C; $P_{L(AV)}$ = 11 W	1 3.2	K/W

<sup>[1]</sup> Thermal resistance is determined under specified RF operating conditions

#### **Broadband power LDMOS transistor**

### 6. Characteristics

Table 6. DC characteristics

 $T_i = 25$  °C unless otherwise specified

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 0.5 \text{ mA}$	65	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	$V_{DS}$ = 10 V; $I_{D}$ = 18 mA	1.4	1.9	2.4	V
I <sub>DSS</sub>	drain leakage current	$V_{GS}$ = 0 V; $V_{DS}$ = 28 V	-	-	1.5	μА
I <sub>DSX</sub>	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $V_{DS} = 10 \text{ V}$	-	3.1	-	Α
I <sub>GSS</sub>	gate leakage current	$V_{GS}$ = 11 V; $V_{DS}$ = 0 V	-	-	150	nA
g <sub>fs</sub>	forward transconductance	$V_{DS}$ = 10 V; $I_{D}$ = 0.9 A	-	0.5	-	S
$R_{DS(on)} \\$	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $I_D = 0.625 \text{ A}$	-	0.4	-	Ω

#### Table 7. AC characteristics

 $T_i = 25$  °C unless otherwise specified

Syı	nbol	Parameter	Conditions	Min	Тур	Max	Unit
C <sub>rs</sub>		feedback capacitance	$V_{GS} = 0 \text{ V}; V_{DS} = 28 \text{ V};$ f = 1 MHz	-	0.5	-	pF

### Table 8. RF characteristics

PAR 7.5 dB at 0.01 % probability on CCDF; 3GPP test model 1; 1-64 PDPCH; RF performance at  $V_{DS}$  = 28 V;  $I_{Dq}$  = 100 mA;  $T_{case}$  = 25 °C; unless otherwise specified; in a class-AB production test circuit.

oacc	•	•				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Test sign	al: 2-carrier W-CDMA	f <sub>1</sub> = 2112.5 MHz; f <sub>2</sub> = 2117.5 MHz; f <sub>3</sub> = 21	62.5 MHz	z; f <sub>4</sub> = 2	167.5 N	1Hz
G <sub>p</sub>	power gain	$P_{L(AV)} = 0.7 W$	-	18.5	-	dB
$\eta_{D}$	drain efficiency	$P_{L(AV)} = 0.7 W$	-	15	-	%
ACPR	adjacent channel power ratio	$P_{L(AV)} = 0.7 W$	-	-50	-	dBc
Test sign	al: 1-carrier W-CDMA	f <sub>1</sub> = 2112.5 MHz; f <sub>2</sub> = 2167.5 MHz				
G <sub>p</sub>	power gain	$P_{L(AV)} = 2 W$	17.3	19.3	-	dB
$\eta_{D}$	drain efficiency	$P_{L(AV)} = 2 W$	29	31	-	%
ACPR	adjacent channel power ratio	$P_{L(AV)} = 2 W$	-	-39	-36	dBc

### 7. Test information

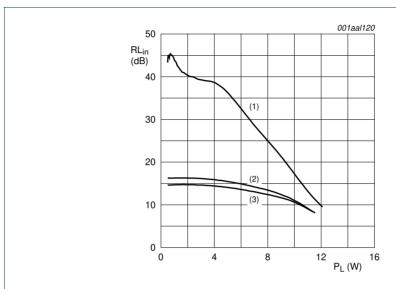
### 7.1 Ruggedness in class-AB operation

The BLF640 is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions:  $V_{DS}$  = 28 V; f = 2140 MHz at  $P_{L}$  = 10 W.

#### **Broadband power LDMOS transistor**

### 7.2 Graphical data

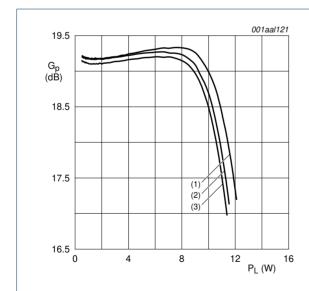
### 7.2.1 CW



 $V_{DS} = 28 \text{ V}; I_{Dq} = 100 \text{ mA}.$ 

- (1) f = 2.11 GHz
- (2) f = 2.14 GHz
- (3) f = 2.17 GHz

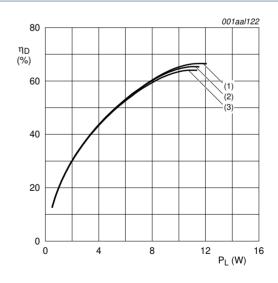
Input return loss as a function of load power; typical values



 $V_{DS}$  = 28 V;  $I_{Dq}$  = 100 mA.

- (1) f = 2.11 GHz
- (2) f = 2.14 GHz
- (3) f = 2.17 GHz

Power gain as a function of load power; typical Fig 2. values



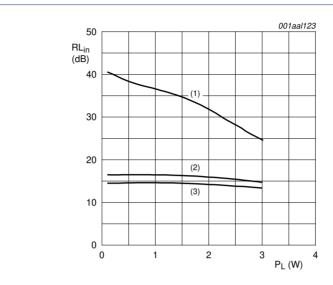
 $V_{DS}$  = 28 V;  $I_{Dq}$  = 100 mA.

- (1) f = 2.11 GHz
- (2) f = 2.14 GHz
- (3) f = 2.17 GHz

Drain efficiency as a function of load power; Fig 3. typical values

#### **Broadband power LDMOS transistor**

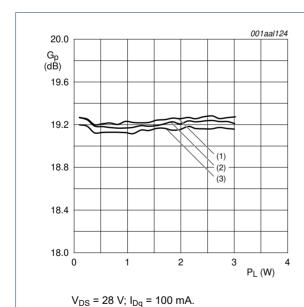
#### 7.2.2 1-Carrier W-CDMA



 $V_{DS} = 28 \text{ V}; I_{Dq} = 100 \text{ mA}.$ 

- (1) f = 2.11 GHz
- (2) f = 2.14 GHz
- (3) f = 2.17 GHz

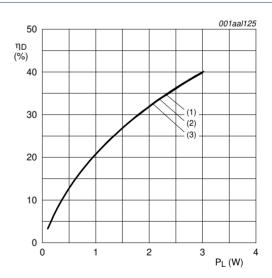
Fig 4. Input return loss as a function of load power; typical values



(4) f = 2.44 CU =

- (1) f = 2.11 GHz
- (2) f = 2.14 GHz
- (3) f = 2.17 GHz

Fig 5. Power gain as a function of load power; typical values

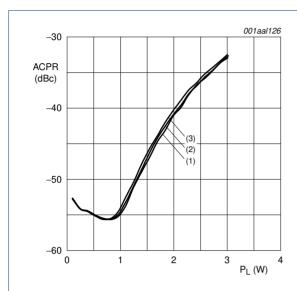


 $V_{DS} = 28 \text{ V}; I_{Dq} = 100 \text{ mA}.$ 

- (1) f = 2.11 GHz
- (2) f = 2.14 GHz
- (3) f = 2.17 GHz

Fig 6. Drain efficiency as a function of load power; typical values

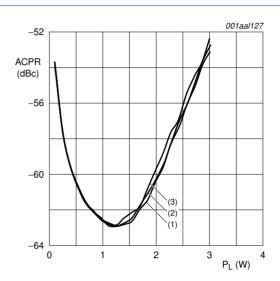
#### **Broadband power LDMOS transistor**



 $V_{DS}$  = 28 V;  $I_{Dq}$  = 100 mA; carrier spacing 5 MHz.

- (1) f = 2.11 GHz
- (2) f = 2.14 GHz
- (3) f = 2.17 GHz

Fig 7. Adjacent channel power ratio as a function of load power; typical values

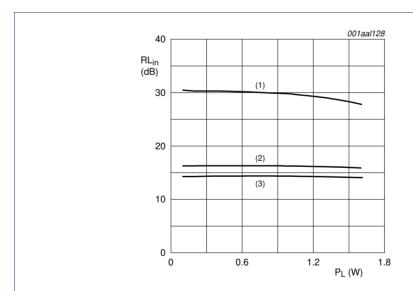


 $V_{DS}$  = 28 V;  $I_{Dq}$  = 100 mA; carrier spacing 10 MHz.

- (1) f = 2.11 GHz
- (2) f = 2.14 GHz
- (3) f = 2.17 GHz

Fig 8. Adjacent channel power ratio as a function of load power; typical values

### 7.2.3 2-Carrier W-CDMA

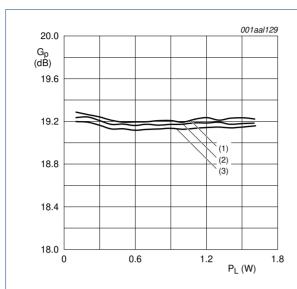


 $V_{DS}$  = 28 V;  $I_{Dq}$  = 100 mA.

- (1) f = 2.11 GHz
- (2) f = 2.14 GHz
- (3) f = 2.17 GHz

Fig 9. Input return loss as a function of load power; typical values

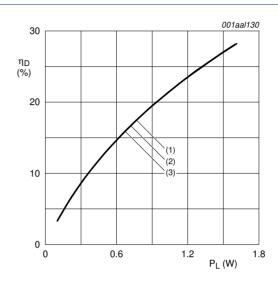
#### **Broadband power LDMOS transistor**



$$V_{DS} = 28 \text{ V}; I_{Dq} = 100 \text{ mA}.$$

- (1) f = 2.11 GHz
- (2) f = 2.14 GHz
- (3) f = 2.17 GHz

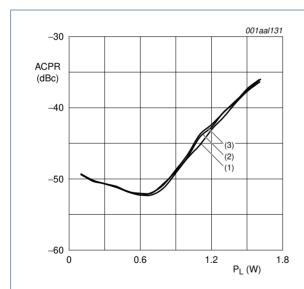
Fig 10. Power gain as a function of load power; typical values



 $V_{DS} = 28 \text{ V}; I_{Dq} = 100 \text{ mA}.$ 

- (1) f = 2.11 GHz
- (2) f = 2.14 GHz
- (3) f = 2.17 GHz

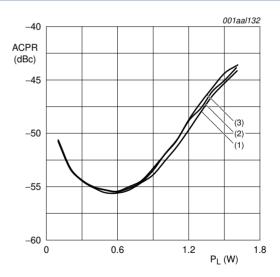
Fig 11. Drain efficiency as a function of load power; typical values



 $V_{DS}$  = 28 V;  $I_{Dq}$  = 100 mA; carrier spacing 5 MHz.

- (1) f = 2.11 GHz
- (2) f = 2.14 GHz
- (3) f = 2.17 GHz

Fig 12. Adjacent channel power ratio as a function of load power; typical values



 $V_{DS}$  = 28 V;  $I_{Dq}$  = 100 mA; carrier spacing 10 MHz.

- (1) f = 2.11 GHz
- (2) f = 2.14 GHz
- (3) f = 2.17 GHz

Fig 13. Adjacent channel power ratio as a function of load power; typical values

### **Broadband power LDMOS transistor**

#### Package outline 8.

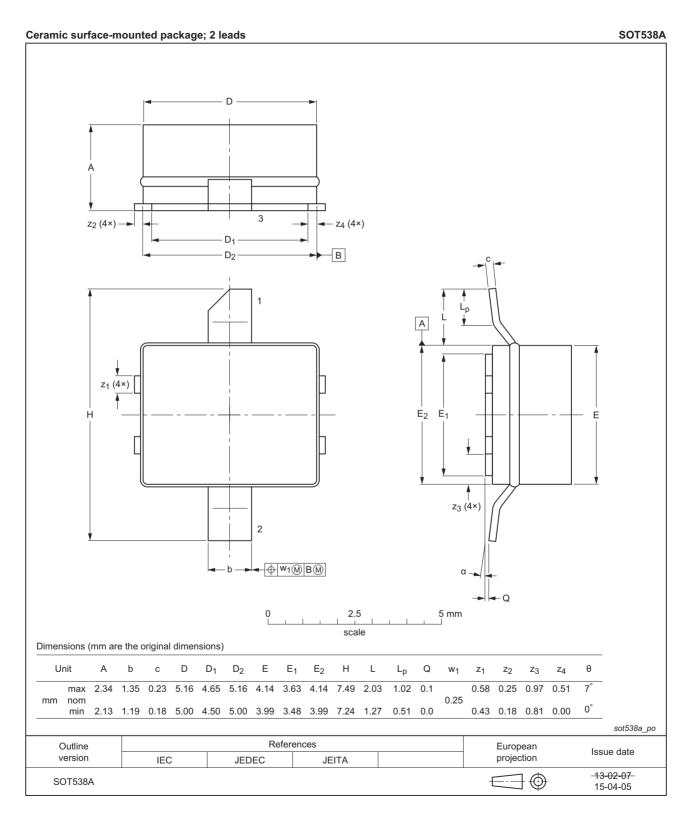


Fig 14. Package outline SOT538A

### **Broadband power LDMOS transistor**

# 9. Handling information

#### CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the *ANSI/ESD S20.20*, *IEC/ST 61340-5*, *JESD625-A* or equivalent standards.

# 10. Abbreviations

Table 9. Abbreviations

Acronym	Description
3GPP	3rd Generation Partnership Project
CCDF	Complementary Cumulative Distribution Function
CW	Continuous Wave
DPCH	Dedicated Physical CHannel
ESD	ElectroStatic Discharge
HF	High Frequency
LDMOS	Laterally Diffused Metal Oxide Semiconductor
PAR	Peak-to-Average Ratio
PDPCH	transmission Power of the Dedicated Physical CHannel
PHS	Personal Handy-phone System
VSWR	Voltage Standing Wave Ratio
W-CDMA	Wideband Code Division Multiple Access

# 11. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLF640#3	20150901	Product data sheet	-	BLF640 v.2
Modifications:	The format of this document has been redesigned to comply with the new identity guidelines of Ampleon.			
	<ul> <li>Legal texts ha</li> </ul>	ve been adapted to the new co	mpany name where a	appropriate.
BLF640 v.2	20130411	Product data sheet	-	BLF640 v.1
BLF640 v.1	20121207	Product data sheet	-	-

#### **Broadband power LDMOS transistor**

### 12. Legal information

#### 12.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="https://www.ampleon.com">https://www.ampleon.com</a>.

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### **Broadband power LDMOS transistor**

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